



Product Summary

BV _{DSS}	Rds(on)	Ι _D Tc = +25°C (Note 7)
60V	8mΩ @ V _{GS} = 10V	100A
60.4	12mΩ @ V _{GS} = 4.5V	85A

Description

This new generation n-channel enhancement mode MOSFET is designed to minimize $R_{\text{DS}(\text{ON})}$ yet maintain superior switching performance.

Applications

- Notebook battery power managements
- DC-DC converters
- Load switches

Features

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.
 - https://www.diodes.com/quality/product-definitions/
- An automotive-compliant part is available under separate datasheet (<u>DMTH6010LPSQ</u>)

Mechanical Data

• Package: PowerDI[®]5060-8

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Internal Schematic

- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)

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• Weight: 0.097 grams (Approximate)



Top View

Site 2:

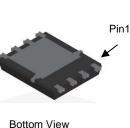
Notes:

Site 1:

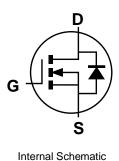
PowerDI5060-8/SWP (Type UX)

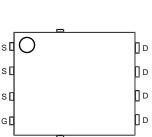


Top View



Bottom View





Top View

Pin Configuration

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Πр

ПD

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Top View Pin Configuration

EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

Pin1

G

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

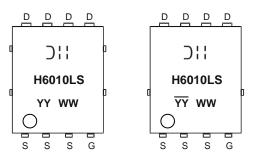


Ordering Information (Note 4)

Part Number	Baskaga	Packing		
Part Number	Package	Qty.	Carrier	
DMTH6010LPS-13	PowerDI5060-8	2,500	Tape & Reel	
DMTH6010LPS-13	PowerDI5060-8/SWP (Type UX)	2,500	Tape & Reel	

Note: 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage Gate-Source Voltage		VDSS	60	V
		V _{GSS}	±20	V
Continuous Drain Current (Note 5)	T _A = +25°C T _A = +100°C	D	13.5 10.4	A
Continuous Drain Current (Notes 6 & 7)	T _C = +25°C T _C = +100°C	١D	100 75	A
Maximum Continuous Body Diode Forward Current (Note 6)		ls	100	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		Ідм	400	А
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)		lsм	400	А
Avalanche Current, L=0.1mH		las	20	А
Avalanche Energy, L=0.1mH		Eas	20	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	2.6	W
Thermal Resistance, Junction to Ambient (Note 5)		Reja	57	°C/W
Total Power Dissipation (Note 6)	Tc = +25°C	PD	136	W
Thermal Resistance, Junction to Case (Note 6)		Rejc	1.1	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

6. Thermal resistance from junction to soldering point (on the exposed drain pad).

7. Limited by package.

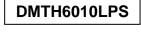


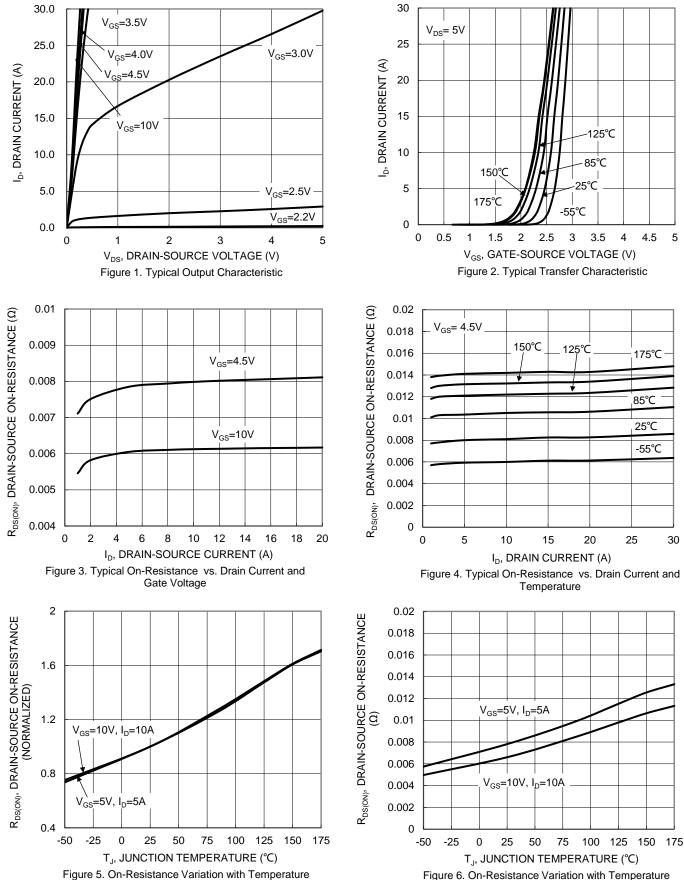
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

		1					
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)					-		
Drain-Source Breakdown Voltage	BVDSS	60		—	V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS		—	1	μA	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}		—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	Vgs(th)	1	_	3	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	
Static Drain-Source On-Resistance	Brayon		5.4	8	mΩ	$V_{GS} = 10V, I_{D} = 20A$	
Static Drain-Source On-Resistance	RDS(ON)		8.3	12	11152	$V_{GS} = 4.5V, I_{D} = 20A$	
Diode Forward Voltage	V _{SD}		0.8	1.2	V	$V_{GS} = 0V, I_{S} = 20A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss		2,090	—			
Output Capacitance	Coss		746	—	pF	$V_{DS} = 30V, V_{GS} = 0V,$ f = 1MHz	
Reverse Transfer Capacitance	Crss		38.5	-			
Gate Resistance	Rg	0.2	0.59	1.5	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg		19.3	_			
Total Gate Charge (V _{GS} = 10V)	Qg	_	41.3	—	nC	V _{DS} = 30V, I _D = 20A	
Gate-Source Charge	Q _{gs}	_	6	—	nc		
Gate-Drain Charge	Q _{gd}	_	8.8	—			
Turn-On Delay Time	t _{D(ON)}	_	5.7	—			
Turn-On Rise Time	tR	_	4.3	—	ns	$V_{DD} = 30V$, $V_{GS} = 10V$, $I_D = 20A$, $R_G = 3\Omega$	
Turn-Off Delay Time	tD(OFF)		23.4	—			
Turn-Off Fall Time	tF		9.7	—			
Body Diode Reverse Recovery Time	trr	_	35.4	—	ns		
Body Diode Reverse Recovery Charge	Q _{RR}		38.2	—	nC	I _F = 20A, di/dt = 100A/µs	

Notes:8. Short duration pulse test used to minimize self-heating effect.9. Guaranteed by design. Not subject to product testing.

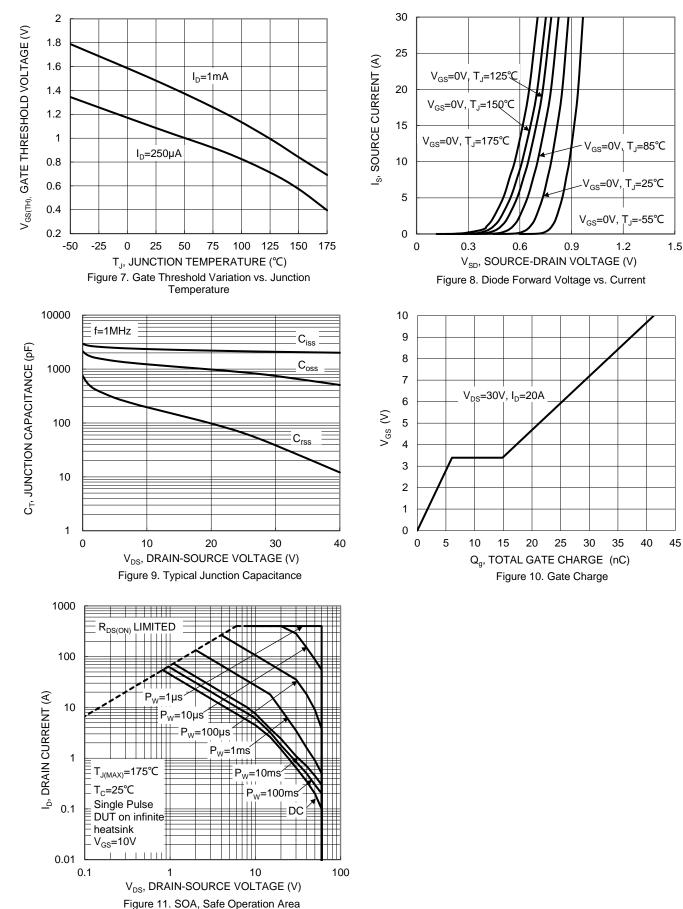




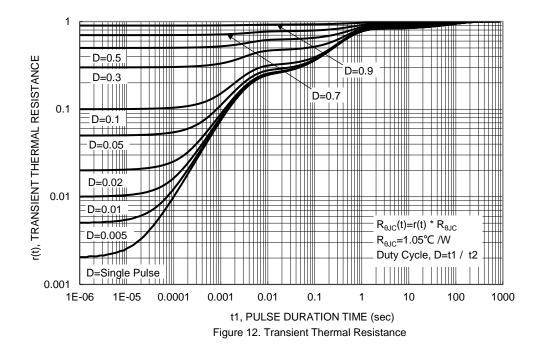




DMTH6010LPS





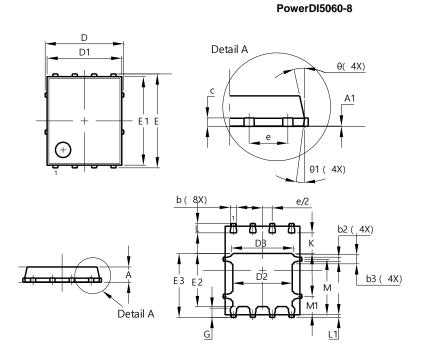




Package Outline Dimensions

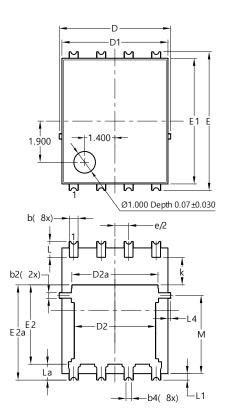
Please see http://www.diodes.com/package-outlines.html for the latest version.

Site 1:

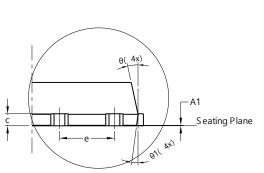


PowerDI5060-8					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0.00	0.05	-		
b	0.33	0.51	0.41		
b2	0.200	0.350	0.273		
b3	0.40	0.80	0.60		
С	0.230	0.330	0.277		
D		5.15 BSC			
D1	4.70	5.10	4.90		
D2	3.70	4.10	3.90		
D3	3.90	4.30	4.10		
Е	(6.15 BSC	;		
E1	5.60	6.00	5.80		
E2	3.28	3.68	3.48		
E3	3.99	4.39	4.19		
е	1.27 BSC				
G	0.51	0.71	0.61		
K	0.51	-	-		
L	0.51	0.71	0.61		
L1	0.100	0.200	0.175		
М	3.235	4.035	3.635		
M1	1.00	1.40	1.21		
Θ	10°	12°	11°		
Θ1	6°	8°	7°		
All Dimensions in mm					

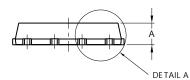
Site 2:



PowerDI5060-8/SWP (Type UX)



DETAIL A



(Type UX) Dim Min Max Type A 0.90 1.10 1.00 A 0.90 1.10 1.00 A 0.90 1.10 1.00 A 0.90 0.05 b 0.30 0.50 0.47 b2 0.20 0.35 0.28 b4 0-25REF c 0.230 0.300 0.27 D 5.15 BSC D1 4.70 5.10 4.90 D2 3.56 3.96 3.76 D2a 3.78 4.18 3.98	PowerDI5060-8/SWP			
A 0.90 1.10 1.00 A1 0 0.05 b 0.30 0.50 0.4' b2 0.20 0.35 0.25 b4 0.25REF C 0.330 0.27 D 5.15 BSC D1 4.70 5.10 4.90 D2 3.56 3.96 3.76 D2a 3.78 4.18 3.98				
A1 0 0.05 b 0.30 0.50 0.44 b2 0.20 0.35 0.25 b4 0.25REF c 0.230 0.330 0.27 D 5.15 BSC D1 4.70 5.10 4.90 D2 3.56 3.96 3.76 D2a 3.78 4.18 3.98)			
b 0.30 0.50 0.47 b2 0.20 0.35 0.25 b4 0.25REF 0.25 0.25 c 0.230 0.330 0.27 D 5.15 BSC 0.10 4.90 D1 4.70 5.10 4.90 D2 3.56 3.96 3.76 D2a 3.78 4.18 3.98)			
b2 0.20 0.35 0.25 b4 0.25REF 0.25 0.25 c 0.230 0.330 0.27 D 5.15 BSC 0.10 0.90 D1 4.70 5.10 4.90 D2 3.56 3.96 3.76 D2a 3.78 4.18 3.98				
b4 0.25REF c 0.230 0.330 0.27 D 5.15 BSC D1 4.70 5.10 4.90 D2 3.56 3.96 3.76 D2a 3.78 4.18 3.98				
c 0.230 0.330 0.27 D 5.15 BSC D1 4.70 5.10 4.90 D2 3.56 3.96 3.76 D2a 3.78 4.18 3.98	5			
D 5.15 BSC D1 4.70 5.10 4.90 D2 3.56 3.96 3.76 D2a 3.78 4.18 3.98				
D1 4.70 5.10 4.90 D2 3.56 3.96 3.76 D2a 3.78 4.18 3.98	7			
D2 3.56 3.96 3.76 D2a 3.78 4.18 3.98				
D2a 3.78 4.18 3.98				
	3			
E 6.40 BSC				
E1 5.60 6.00 5.80				
E2 3.46 3.86 3.66	5			
E2a 4.195 4.595 4.39	5			
e 1.27BSC				
k 1.05				
L 0.635 0.835 0.73				
La 0.635 0.835 0.73				
L1 0.200 0.400 0.30	0			
L1a 0.050REF				
L4 0.025 0.225 0.12				
M 3.205 4.005 3.60	5			
θ 10° 12° 11°				
θ1 6° 8° 7°				
All Dimensions in mm				

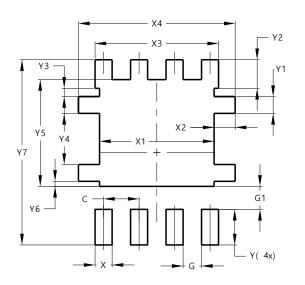


Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

Site 1:

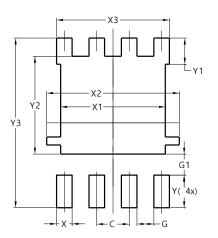
PowerDI5060-8



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	0.755
X3	4.420
X4	5.610
Y	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y7	6.610

Site 2:

PowerDI5060-8/SWP (Type UX)



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
X	0.610
X1	4.100
X2	5.190
X3	4.420
Y	1.270
Y1	1.020
Y2	3.810
Y3	6.610



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